

1498003-10M000

10.0 MHz, 9x14 mm, SMT OCXO

Features

- Industry Standard 9x14mm footprint
- 3.3Vdc Supply Voltage
- LVCMOS Output
- Low Phase Noise



Electrical Specifications

Parameter	Conditions & Remarks	Min	Typical	Max	Unit
Operating Conditions					
Operating Temperature Range	Тор	0	-	+70	°C
Supply Voltage	V _{CC} ; ± 5%	3.135	3.300	3.465	Vdc
Dawer Consumption	Warm-up	-	-	2.7	W
Power Consumption	Steady State; T _A = 25°C; Still Air	-	0.7	1	W
Load		13.5	15	16.5	pF
Frequency Stability					
Frequency	F _{NOM}		10.000		MHz
Frequency Calibration	25°C at time of shipment	-	-	±200	ppb
Freq. vs Temperature	ΔF/F	-	-	±10	ppb
Freq. vs Supply Voltage	V _{CC} ±5%	-	-	±5	ppb
		-	-	±1	ppb/day
Freq. vs Time (Aging)	After 30 days operation	-	-	±100	ppb/year
		-	-	±0.5	ppm/10 yrs
Free run accuracy	All causes - 10 years	-	-	±1.0	ppm
Frequency Retrace	0.5 hours on after 24 hours off, preceded by 24 hours on. Ref to turn-off frequency	-	-	+/-50	ppb
Allan Deviation	1.0 sec	-	-	0.05	ppb
Warm-up time	Within 50 ppb ref to 1hour	-	-	5	min
Holdover stability (24 hours)	Over operating temperature range.	-	-	11	ppb, pk-pk
Wander Generation	Generation Meets Stratum 3E MTIE and TDEV per Telcordia GR-1244-CORRE			E	



Electrical Specifications (Continued)

Parameter	Conditions & Remarks		Min	Typical	Max	Unit
Output Parameters						
Output Signal		LVCMOS Square Wave				
A mana literata		V _{OL}	-	-	0.4) / -l
Amplitude		V_{OH}	2.4	-	-	Vdc
Rise/Fall Times	10% to 90%, 15 pf load		-	-	5	ns
Duty Cycle	@50% of output signal		45	-	55	%
		1Hz	-	-85	-	
		10Hz	-	-115	-	
Phase Noise		100Hz	-	-138	-	dBc/Hz
Thuse Holse		1KHz	-	-148	-	авсит
		10KHz	-	-152	-	
Electronic Frequency (Control - EFC	100KHz		-154	-	
EFC Control Voltage	V _C		0.0	1.65	3.3	Volts
Frequency Adjust Range			±0.7	-	±2.0	ppm
Slope	Positive, monotonic		-	-	-	
Input Impedance	Z _{IN}		100	-	-	Kohms
Linearity			-	-	10	%

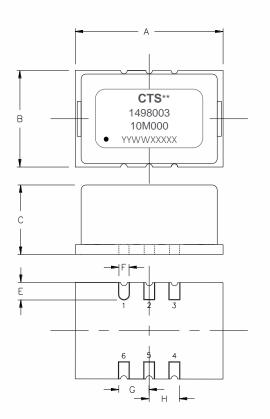
Mechanical and Environmental

Storage Temperature	-55 to +105°C		
Reflow Profile	IPC/JEDEC J-STD-20, Pb-Free process Note: This product is not designed to be reflowed in an inverted position.		
Mechanical Shock 100g, 6mS duration, 1/2 sine wave, 3 shocks each direction along 3 mutually per planes.			
Drop	10 cm height, 3 times onto hard board with 3 cm thickness – IEC60028-2-32 test Ed		
Bumping	40g, 6ms, 4000 ± 10 times in each of three mutually perpendicular axes		
Random Vibration	Frequency range: 1Hz-4Hz-100Hz-200 Acceleration: 0.0001g²/Hz-0.01g²/Hz-0.01g²/Hz-0.001g²/Hz Grms=1.15g 30 minutes, each axis		
Sine Vibration	10-55 Hz, 0.75 mm DA, 30 minutes per axis		
Thermal Shock	-40/+85°C. 0.5 hour dwell with <30 second transitions. 100 cycles		
RoHS	Lead-Free. Fully compliant to RoHS Directive 2011/65/EU		
MSL	Level 2		





Mechanical Specifications



Marking

**		Mfg Site Code		
	YYWWXXXXX	Serial Number (mfg date code = first 4 digits of s/n)		

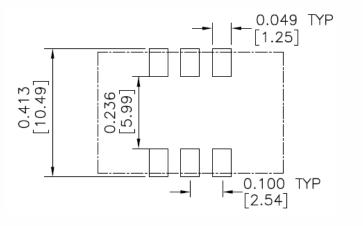
Dimensions (mm)

Symbol	Min	Max	
А	-	14.9	
В	-	9.7	
С	-	7.0	
Е	1.6	1.8	
F	0.9	1.1	
G	2.54 nominal		
Н	2.54 nominal		

Pin Assignments

PAD	Connection	
1	Vc	
2	N/C	
3	Ground	
4	Output	
5	N/C	
6	V _{CC}	

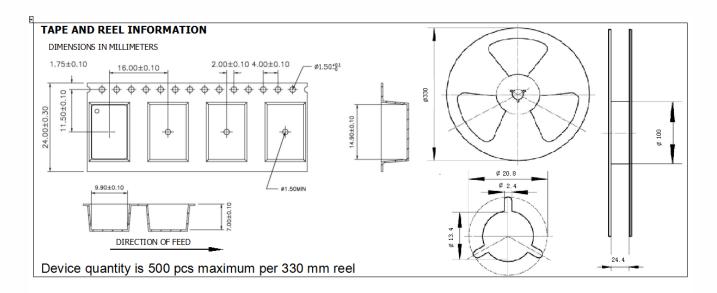
Recommended Solder Pad Geometry:



Inches [mm]

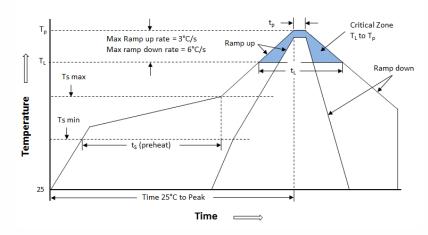


Packing: Tape and Reel



Reflow:

Reflow profile per IPC/JEDEC J-STD-020D



Ts max to T _L (Ramp-up Rate)	3°C/second max	
Preheat		
Temperature Min(Ts Min)	150°C	
Temperature Typical(Ts Typ)	175°C	
Temperature Max.(Ts Max)	200°C	
Time(ts)	60-120 seconds	
Ramp-up Rate(T _L to Tp)	3°C/second max	
Time Maintained Above:		
Temperature(T _L)	217°C	
Time(t _L)	60-150seconds	
Peak Temperature (Tp)	245°C max for 10 seconds	
Time within 5°C of actual peak(t _p)	20 seconds	
Ramp-down Rate	6°C/second max	
Time 25°C to Peak Temperature (t)	8 minutes max	

Note: The temperatures shown represent the device body temperature $% \left(1\right) =\left(1\right) \left(1\right)$

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